Supporting Information

High-Performance Ultra-Low-Voltage Organic Field-effect Transistor Based on Anodized TiO_x Dielectric and Solution-sheared Organic Single Crystal

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Figure S1 Cross-sectional scanning electron microscope (SEM) image of Au/TiO_x/Ti, scale

bar is 50 nm.



Figure S2 (a), (b) AFM image of the surface morphology of Ti thin film and TiOx thin film,

scale bar is 1 µm.



Figure S3 (a) Optical image of the Ag/TiO_x/Ti capacitive device, areal area of top Ag electrode is 0.04 mm², scale bar is 100 μ m. (b) Leakage current density of pure TiO_x dielectric and TiO_x/PS dual dielectrics.



Figure S4 Out-of-plane X-ray diffraction of C₈-BTBT crystal on TiO_x/PS substrate.



Figure S5 AFM image of C₈-BTBT crystal with the thickness estimated at 32.3 nm, scale bar

is 1 µm.



Figure S6 Unit-area capacitance of AlO_x/PS dual dielectrics which using the same process of TiO_x/PS dielectrics.



Figure S7 Surface potential map of evaporated titanium measured by KPFM, scale bar is 1

μm.